



US00D753087S

(12) **United States Design Patent**
Cai

(10) **Patent No.:** **US D753,087 S**

(45) **Date of Patent:** **** Apr. 5, 2016**

(54) **SMART PHONE**

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(CN)

(**) Term: **14 Years**

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(30) **Foreign Application Priority Data**

Aug. 12, 2013 (CN) 2013 3 0385198

(51) **LOC (10) Cl.** **14-03**

(52) **U.S. Cl.**
USPC **D14/138 AA**

(58) **Field of Classification Search**

USPC D14/137, 138 R, 138 AA, 138 C, 138 G,
D14/142, 144, 147, 240, 247, 248, 250,
D14/341-347, 496, 138; D13/168; D18/7;
455/90.2, 90.3, 550.1, 556.1, 556.2;
379/433.01; 348/14.02; D25/119, 121,
D25/123

CPC ... H04M 1/02; H04M 1/0202; H04M 1/0206;
H04M 1/0208; H04M 1/021; H04M 1/0212;
H04M 1/0214; H04M 1/0216; H04M 1/0241;
H04M 1/0264; G06F 1/1626

See application file for complete search history.

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Primary Examiner — Sandra Snapp

(74) *Attorney, Agent, or Firm* — Oppedahl Patent Law Firm
LLC

(57) **CLAIM**

The ornamental design for a smart phone, as shown and described.

DESCRIPTION

FIG. 1 is a front side elevation view of a first embodiment of our new design for a smart phone, with an end piece a rotated position and a stand in an open position.

FIG. 2 is a back side elevation view of FIG. 1.

FIG. 3 is a left side elevation view of FIG. 1.

FIG. 4 is a right side elevation view of FIG. 1.

FIG. 5 is a top side plan view of FIG. 1.

FIG. 6 is a bottom side plan view of FIG. 1.

FIG. 7 is a front side perspective view of FIG. 1.

FIG. 8 is a front side elevation view of the first embodiment electronic device with end piece not rotated and the stand in closed position, it being understood that all other surfaces are the same as the embodiment of FIG. 1.

FIG. 9 is a back side elevation view of FIG. 8.

FIG. 10 is a left side elevation view of FIG. 8.

FIG. 11 is a right side elevation view of FIG. 8.

FIG. 12 is a top side plan view of FIG. 8.

FIG. 13 is a bottom side plan view of FIG. 8.

FIG. 14 is a front top side perspective view of FIG. 8.

FIG. 15 is a front side elevation view of a second embodiment of our new design for a smart phone, with an end piece in a rotated position and a stand in an open position.

FIG. 16 is a back side elevation view of FIG. 15.

FIG. 17 is a left side elevation view of FIG. 15.

FIG. 18 is a right side elevation view of FIG. 15.

FIG. 19 is a top side plan view of FIG. 15.

FIG. 20 is a bottom side plan view of FIG. 15.

FIG. 21 is a front side perspective view of FIG. 15.

FIG. 22 is a front side elevation view of the second embodiment electronic device with end piece not rotated and the stand in closed position, it being understood that all other surfaces are the same as the embodiment of FIG. 15.

FIG. 23 is a back side elevation view of FIG. 22.

FIG. 24 is a left side elevation view of FIG. 22.

FIG. 25 is a right side elevation view of FIG. 22.

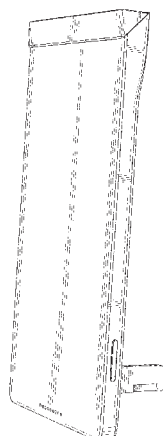
FIG. 26 is a top side plan view of FIG. 22.

FIG. 27 is a bottom side plan view of FIG. 22; and,

FIG. 28 is a front top side perspective view of FIG. 22.

The features shown in broken lines in the drawing depict environmental subject matter and unclaimed borders and form no part of the claimed design. Other than the section disclaimed by the broken lines and unclaimed borders, it is to be understood that all other surfaces are the same in all embodiments.

1 Claim, 20 Drawing Sheets



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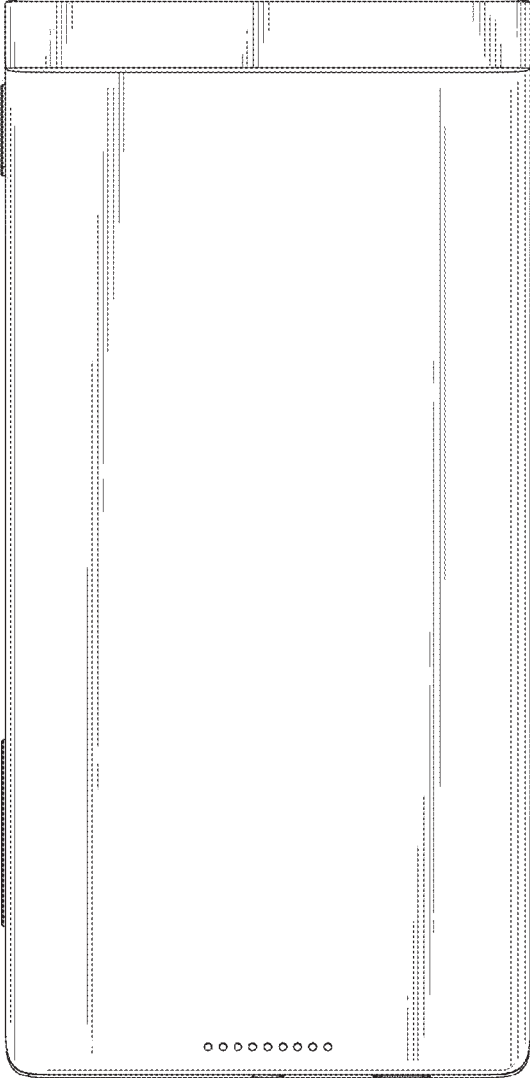


FIG.1

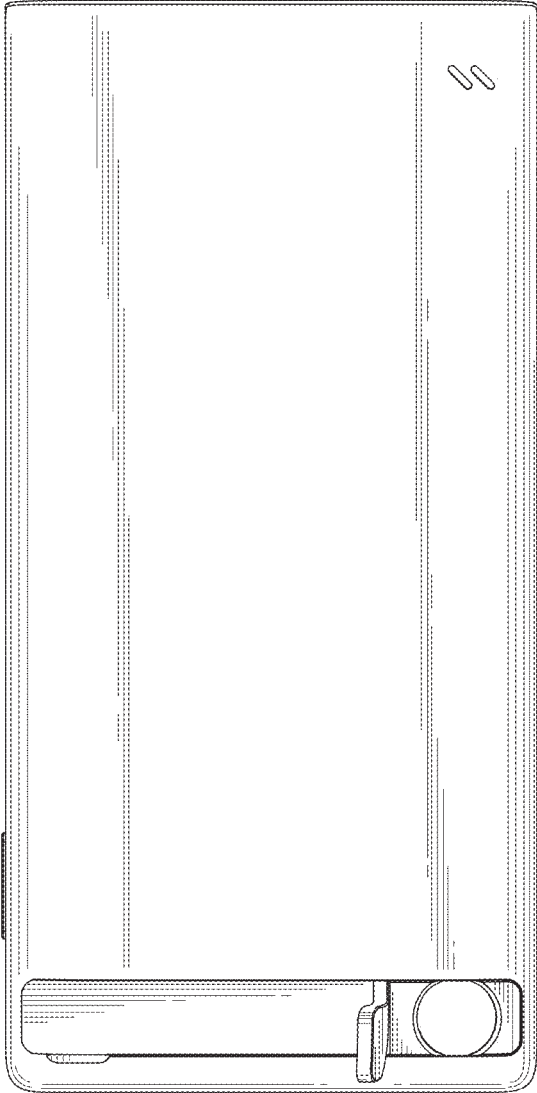


FIG.2

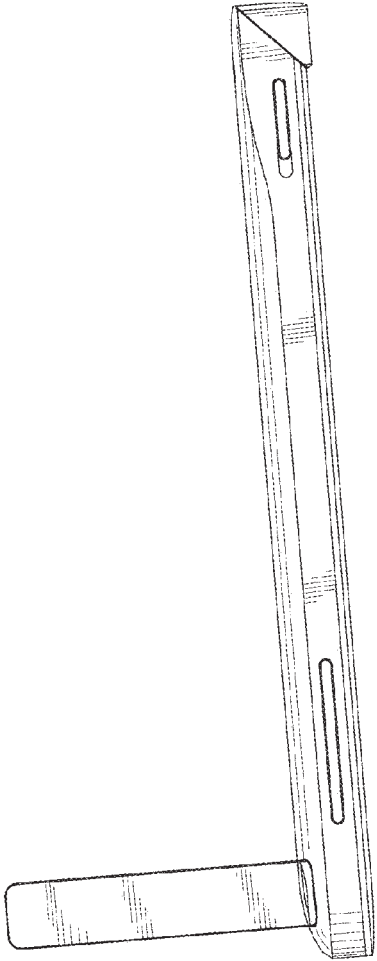


FIG.3

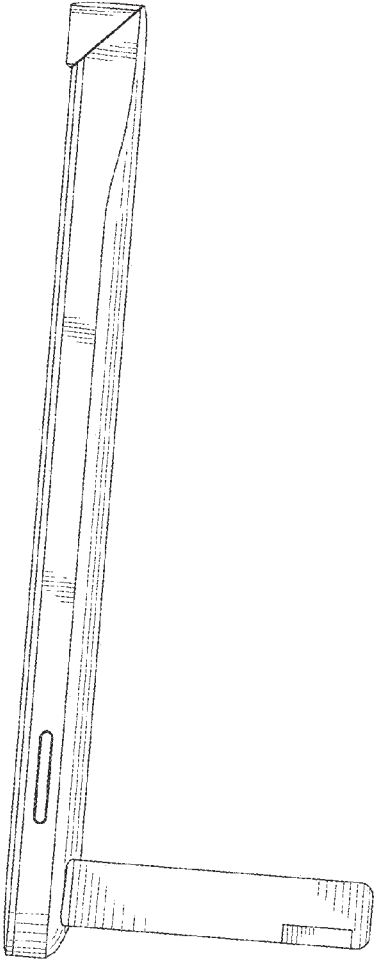


FIG.4

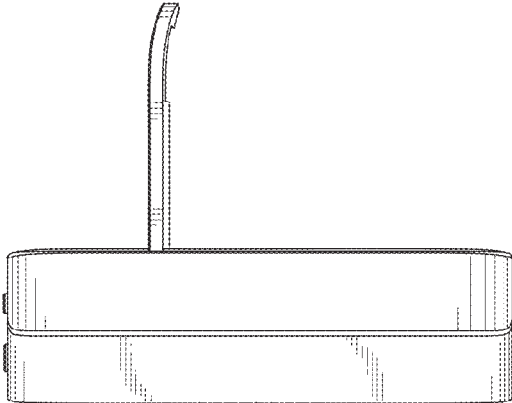


FIG.5

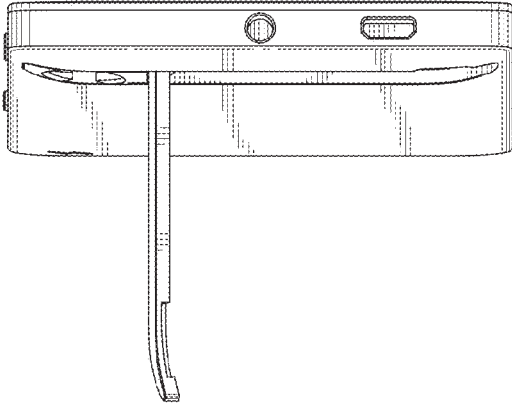


FIG.6

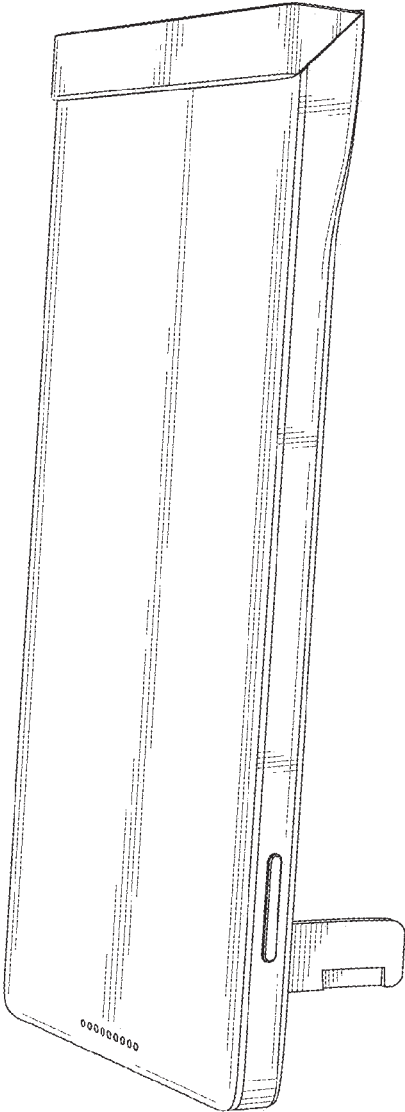


FIG.7

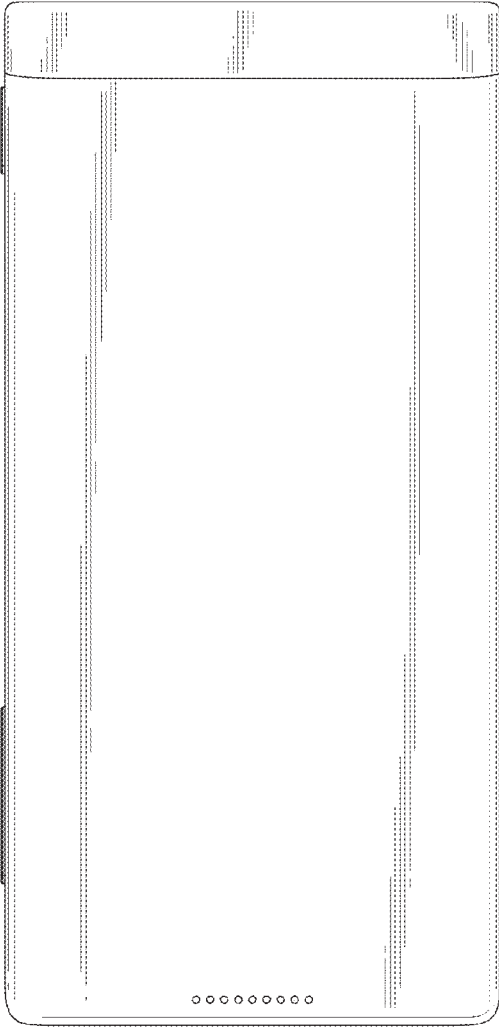


FIG.8

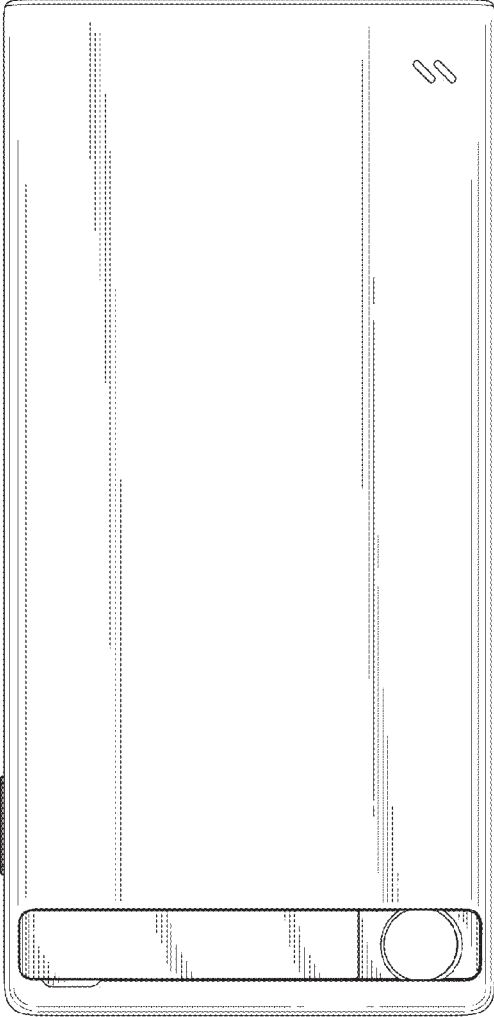


FIG.9



FIG. 10

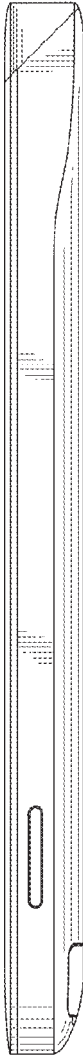


FIG. 11

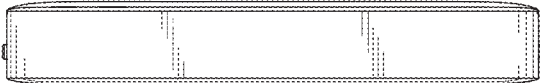


FIG. 12

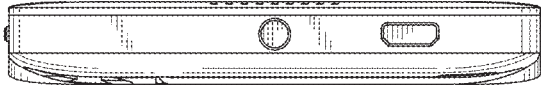


FIG. 13

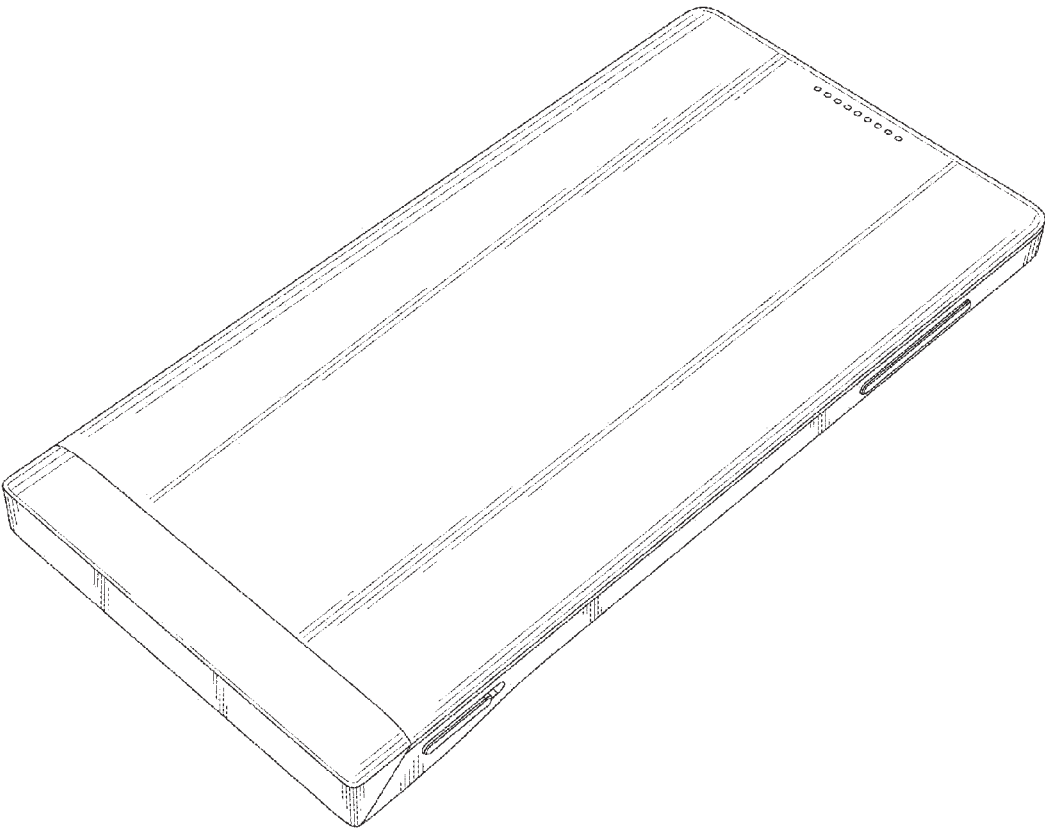


FIG.14

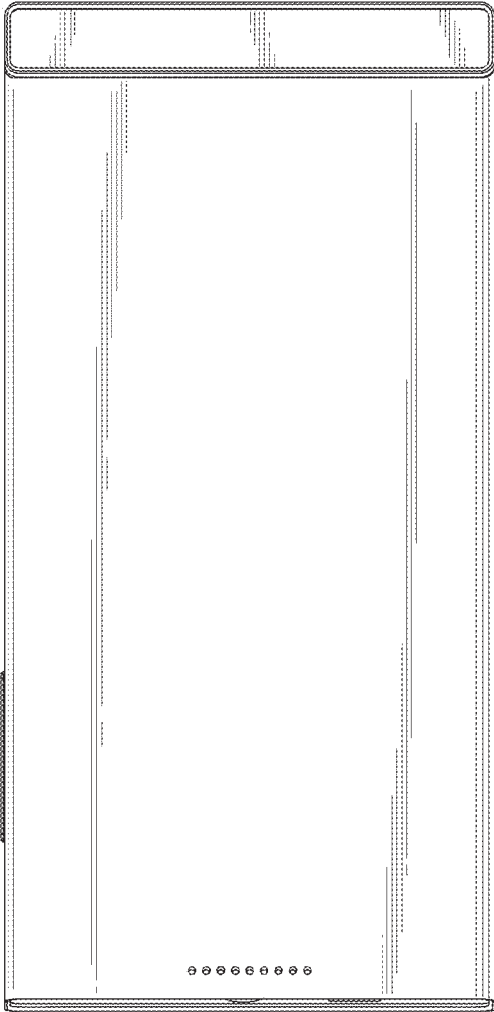


FIG.15

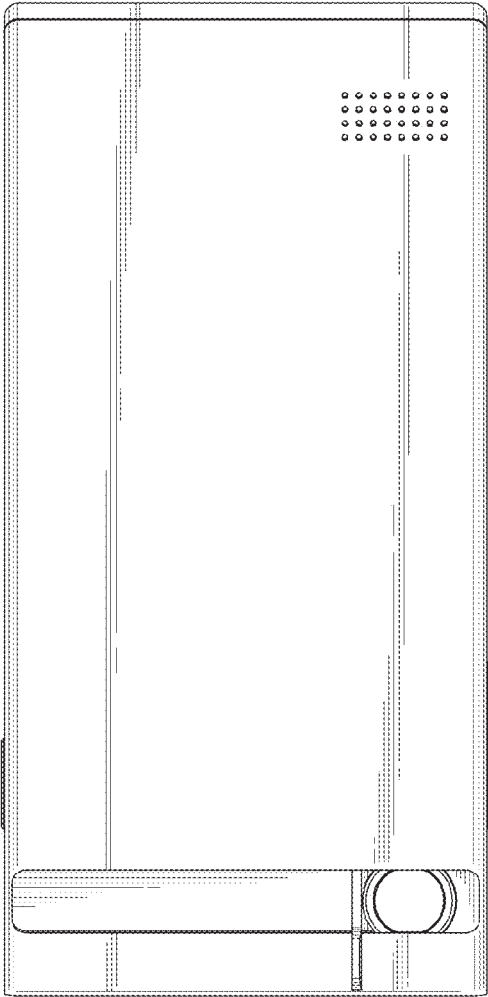


FIG.16

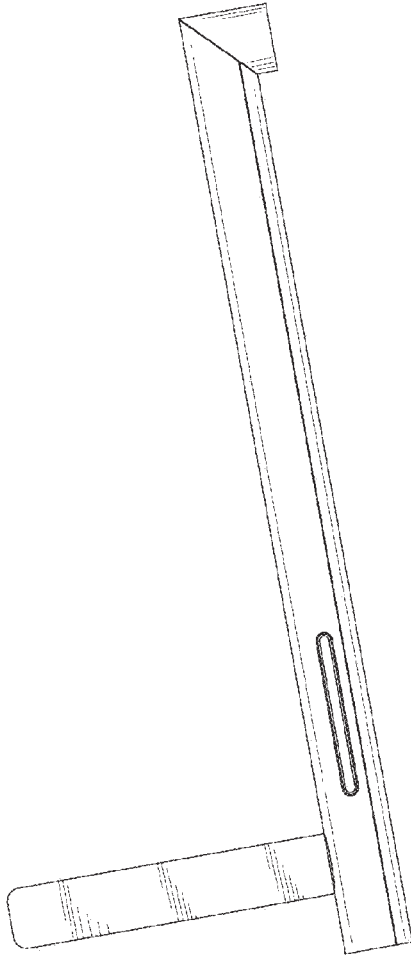


FIG.17

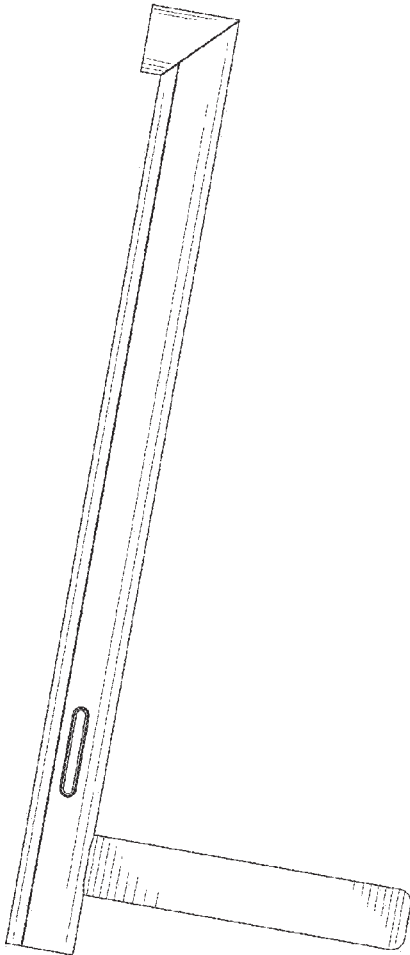


FIG.18

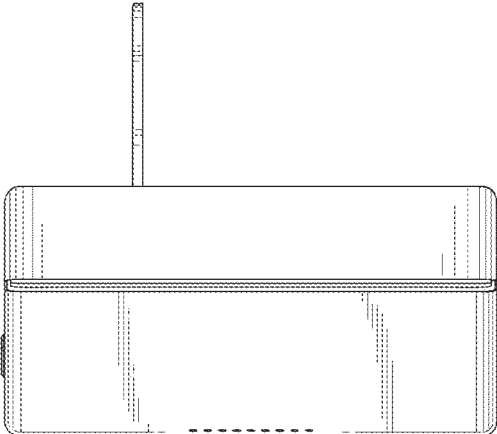


FIG.19

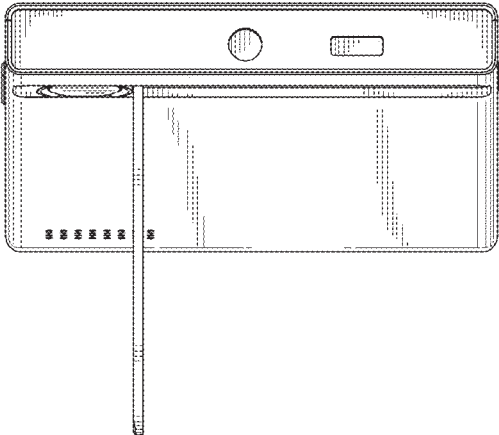


FIG.20

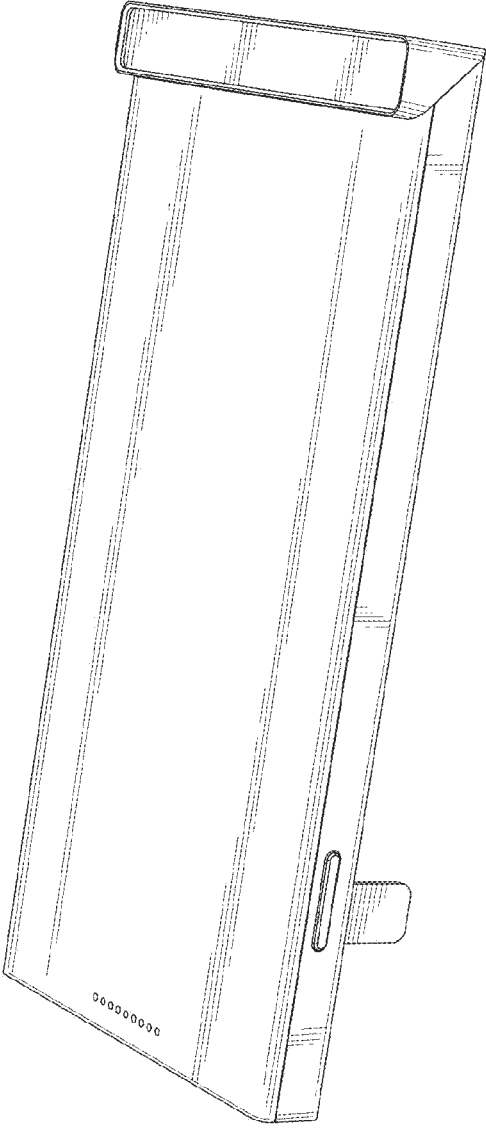


FIG.21

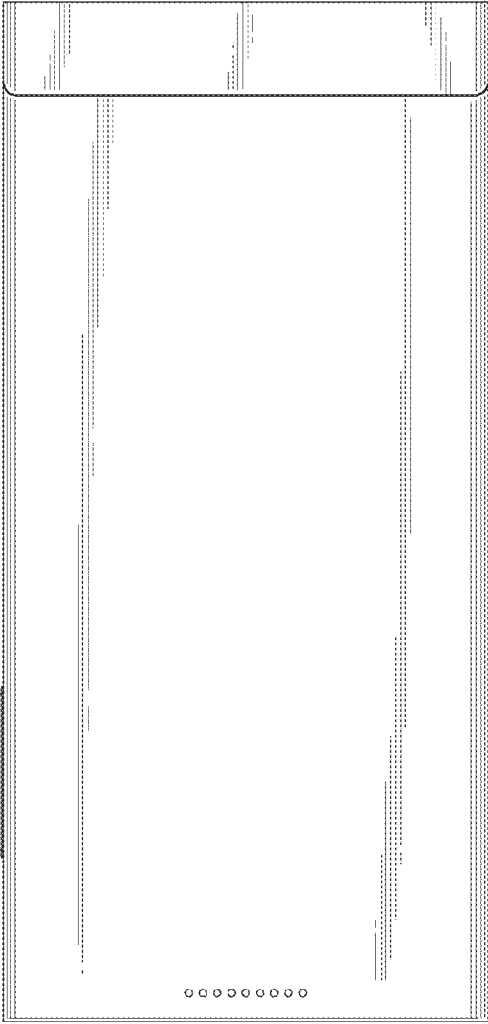


FIG.22

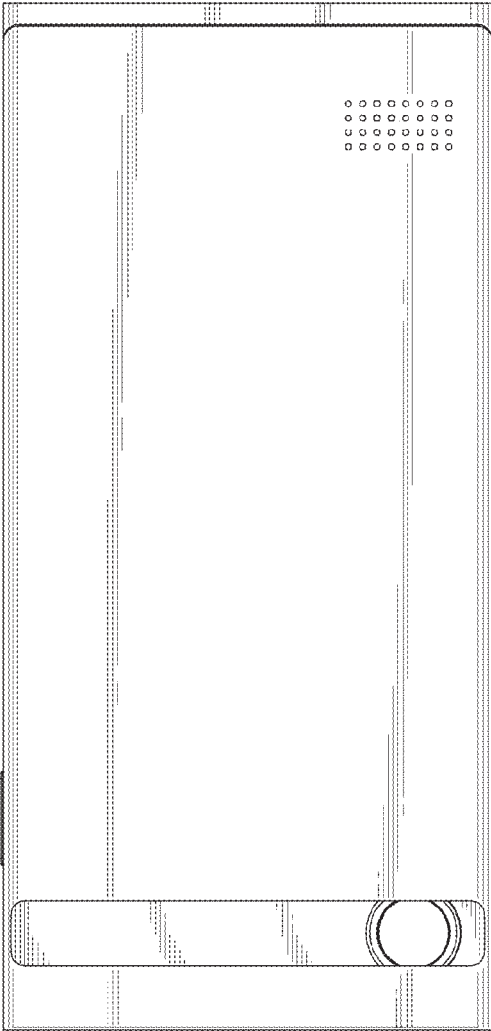


FIG.23

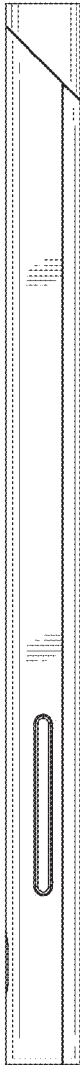


FIG.24



FIG.25



FIG.26

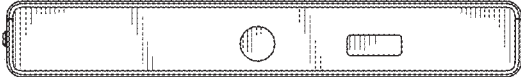


FIG.27

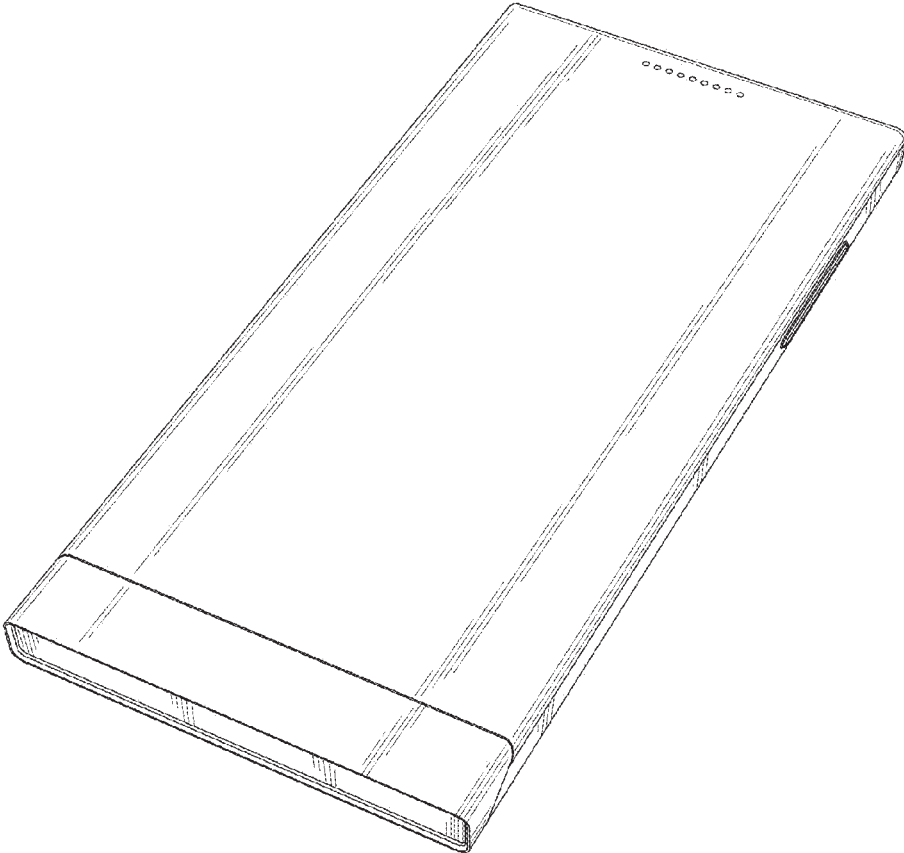


FIG.28